

Data sheet acquired from Harris Semiconductor

## *CD74HC257, CD74HCT257*

### High Speed CMOS Logic Quad 2-Input Multiplexer with Three-State Non-Inverting Outputs

November 1997

#### **Features**

- · Buffered Inputs
- Typical Propagation Delay (In to Output) = 12ns at V<sub>CC</sub> = 5V, C<sub>L</sub> = 15pF, T<sub>A</sub> = 25°C
- Fanout (Over Temperature Range)
  - Standard Outputs................ 10 LSTTL Loads
  - Bus Driver Outputs ............. 15 LSTTL Loads
- Wide Operating Temperature Range . . . -55°C to 125°C
- Balanced Propagation Delay and Transition Times
- Significant Power Reduction Compared to LSTTL Logic ICs
- HC Types
  - 2V to 6V Operation
  - High Noise Immunity:  $N_{IL}$  = 30%,  $N_{IH}$  = 30% of  $V_{CC}$  at  $V_{CC}$  = 5V
- HCT Types
  - 4.5V to 5.5V Operation
  - Direct LSTTL Input Logic Compatibility, V<sub>IL</sub>= 0.8V (Max), V<sub>IH</sub> = 2V (Min)
  - CMOS Input Compatibility,  $I_I \le 1\mu A$  at  $V_{OL}$ ,  $V_{OH}$

#### Description

The Harris CD74HC257 and CD74HCT257 are quad 2-input multiplexers which select four bits of data from two sources under the control of a common Select Input (S). The Output Enable input  $(\overline{OE})$  is active LOW. When  $\overline{OE}$  is HIGH, all of the outputs (1Y-4Y) are in the high impedance state regardless of all other input conditions.

Moving data from two groups of registers to four common output busses is a common use of the 257. The state of the Select input determines the particular register from which the data comes. It can also be used as a function generator.

#### **Ordering Information**

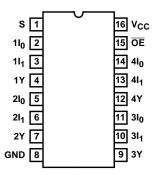
PART NUMBER	TEMP. RANGE (°C)	PACKAGE	PKG. NO.
CD74HC257E	-55 to 125	16 Ld PDIP	E16.3
CD74HCT257E	-55 to 125	16 Ld PDIP	E16.3
CD74HC257M	-55 to 125	16 Ld SOIC	M16.15
CD74HCT257M	-55 to 125	16 Ld SOIC	M16.15

#### NOTES:

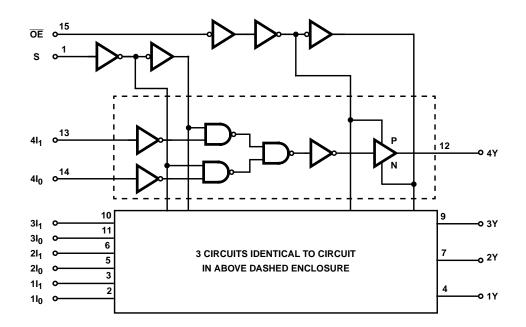
- 1. When ordering, use the entire part number. Add the suffix 96 to obtain the variant in the tape and reel.
- Wafer or die for this part number is available which meets all electrical specifications. Please contact your local sales office or Harris customer service for ordering information.

#### **Pinout**

CD74HC257, CD74HC257 (PDIP, SOIC) TOP VIEW



#### Functional Diagram



#### **TRUTH TABLE**

OUTPUT ENABLE	SELECT INPUT	DATA I	OUTPUT		
ŌĒ	S	I <sub>0</sub> I <sub>1</sub>		Y	
Н	Х	Х	Х	Z	
L	L	L	Х	L	
L	L	Н	Х	Н	
L	Н	Х	L	L	
L	Н	Х	Н	Н	

#### NOTE:

H = High Voltage Level

L = Low Voltage Level X = Don't Care

Z = High Impedance, OFF State

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#### **Absolute Maximum Ratings**

# DC Supply Voltage, V $_{CC}$ ... -0.5V to 7V DC Input Diode Current, I $_{IK}$ For V $_{I}$ < -0.5V or V $_{I}$ > V $_{CC}$ + 0.5V ... ... $\pm 20$ mA DC Output Diode Current, I $_{OK}$ For V $_{O}$ < -0.5V or V $_{O}$ > V $_{CC}$ + 0.5V ... ... $\pm 20$ mA DC Drain Current, per Output, I $_{O}$ For -0.5V < V $_{O}$ < V $_{CC}$ + 0.5V ... ... $\pm 35$ mA DC Output Source or Sink Current per Output Pin, I $_{O}$ For V $_{O}$ > -0.5V or V $_{O}$ < V $_{CC}$ + 0.5V ... ... $\pm 25$ mA DC V $_{CC}$ or Ground Current, I $_{CC}$ ... $\pm 25$ mA

#### **Thermal Information**

Thermal Resistance (Typical, Note 3) $\theta_{JA}$ ( $^{0}$	C/W)
PDIP Package	90
	160
Maximum Junction Temperature	150°C
Maximum Storage Temperature Range65°C to	150°C
Maximum Lead Temperature (Soldering 10s)	300°C
(SOIC - Lead Tips Only)	

#### **Operating Conditions**

Temperature Range, T <sub>A</sub> 55°C to 125°C
Supply Voltage Range, V <sub>CC</sub>
HC Types2V to 6V
HCT Types
DC Input or Output Voltage, V <sub>I</sub> , V <sub>O</sub> 0V to V <sub>CC</sub>
Input Rise and Fall Time
2V
4.5V 500ns (Max)
6V

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

#### NOTE:

3.  $\theta_{JA}$  is measured with the component mounted on an evaluation PC board in free air.

#### **DC Electrical Specifications**

			ST ITIONS	25°C			-40°C TO 85°C		-55°C TO 125°C					
PARAMETER	SYMBOL	V <sub>I</sub> (V)	I <sub>O</sub> (mA)	V <sub>CC</sub> (V)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNITS		
HC TYPES							-							
High Level Input	V <sub>IH</sub>	-	-	2	1.5	-	-	1.5	-	1.5	-	V		
Voltage				4.5	3.15	-	-	3.15	-	3.15	-	V		
				6	4.2	-	-	4.2	-	4.2	-	V		
Low Level Input	V <sub>IL</sub>	-	-	2	-	-	0.5	-	0.5	-	0.5	V		
Voltage				4.5	-	-	1.35	-	1.35	-	1.35	V		
				6	-	-	1.8	-	1.8	-	1.8	V		
High Level Output	V <sub>OH</sub>	V <sub>IH</sub> or	-0.02	2	1.9	-	-	1.9	-	1.9	-	V		
Voltage CMOS Loads		V <sub>IL</sub>	-0.02	4.5	4.4	-	-	4.4	-	4.4	-	V		
					-0.02	6	5.9	-	-	5.9	-	5.9	-	V
High Level Output	1		-6	4.5	3.98	-	-	3.84	-	3.7	-	V		
Voltage TTL Loads			-7.8	6	5.48	-	-	5.34	-	5.2	-	V		
Low Level Output	V <sub>OL</sub>	V <sub>IH</sub> or	0.02	2	-	-	0.1	-	0.1	-	0.1	V		
Voltage CMOS Loads		V <sub>IL</sub>	0.02	4.5	-	-	0.1	-	0.1	-	0.1	V		
			0.02	6	-	-	0.1	-	0.1	-	0.1	V		
Low Level Output	·	-	-	0.26	-	0.33	-	0.4	V					
Voltage TTL Loads			7.8	6	-	-	0.26	-	0.33	-	0.4	V		
Input Leakage Current	l <sub>l</sub>	V <sub>CC</sub> or GND	-	6	-	-	±0.1	-	±1	-	±1	μА		

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#### DC Electrical Specifications (Continued)

	TEST CONDITIONS		25°C			-40°C T	O 85°C	-55°C TO 125°C				
PARAMETER	SYMBOL	V <sub>I</sub> (V)	I <sub>O</sub> (mA)	V <sub>CC</sub> (V)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNITS
Quiescent Device Current	Icc	V <sub>CC</sub> or GND	0	6	-	-	8	-	80	-	160	μА
Three-State Leakage Current	l <sub>OZ</sub>	V <sub>IL</sub> or V <sub>IH</sub>	-	6	-	-	±0.5	-	±5	-	±10	μΑ
HCT TYPES	•		•				•				•	
High Level Input Voltage	V <sub>IH</sub>	-	-	4.5 to 5.5	2	-	-	2	-	2	-	V
Low Level Input Voltage	V <sub>IL</sub>	-	-	4.5 to 5.5	-	-	0.8	-	0.8	-	0.8	V
High Level Output Voltage CMOS Loads	V <sub>ОН</sub>	V <sub>IH</sub> or V <sub>IL</sub>	-0.02	4.5	4.4	-	-	4.4	-	4.4	-	V
High Level Output Voltage TTL Loads			-6	4.5	3.98	-	-	3.84	-	3.7	-	V
Low Level Output Voltage CMOS Loads	V <sub>OL</sub>	V <sub>IH</sub> or V <sub>IL</sub>	0.02	4.5	-	-	0.1	-	0.1	-	0.1	V
Low Level Output Voltage TTL Loads			6	4.5	-	-	0.26	-	0.33	-	0.4	V
Input Leakage Current	II	V <sub>CC</sub> to GND	0	5.5	-	-	±0.1	-	±1	-	±1	μΑ
Quiescent Device Current	I <sub>CC</sub>	V <sub>CC</sub> or GND	0	5.5	-	-	8	-	80	-	160	μА
Additional Quiescent Device Current Per Input Pin: 1 Unit Load (Note 4)	Δl <sub>CC</sub>	V <sub>CC</sub> -2.1	-	4.5 to 5.5	-	100	360	-	450	-	490	μА
Three-State Leakage Current	loz	V <sub>IL</sub> or V <sub>IH</sub>	-	5.5	-	-	±0.5	-	±5	-	±10	μА

#### NOTE:

#### **HCT Input Loading Table**

INPUT	UNIT LOADS
Data	0.95
S	3
ŌĒ	0.6

NOTE: Unit Load is  $\Delta I_{CC}$  limit specified in DC Electrical Specifications table, e.g., 360 $\mu A$  max at 25°C.

<sup>4.</sup> For dual-supply systems theoretical worst case ( $V_I$  = 2.4V,  $V_{CC}$  = 5.5V) specification is 1.8mA.

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#### **Switching Specifications** Input $t_r$ , $t_f = 6ns$

		TEST		25	o <sub>C</sub>	-40°C TO 85°C	-55°C TO 125°C	
PARAMETER	SYMBOL	CONDITIONS	V <sub>CC</sub> (V)	TYP	MAX	MAX	MAX	UNITS
HC TYPES								
Propagation Delay In to Y	t <sub>PLH</sub> , t <sub>PHL</sub>	C <sub>L</sub> = 50pF	2	-	150	190	225	ns
III to 1			4.5	•	30	38	45	ns
		C <sub>L</sub> = 15pF	5	12	-	-	-	ns
		CL = 50pF	6	-	26	33	38	ns
Propagation Delay	t <sub>PLH</sub> , t <sub>PHL</sub>	C <sub>L</sub> = 50pF	2	-	175	220	265	ns
S to Y			4.5	-	35	44	53	ns
		C <sub>L</sub> = 15pF	5	14	-	-	-	ns
		CL = 50pF	6	-	30	37	45	ns
Propagation Delay	t <sub>PLZ</sub> , t <sub>PHZ</sub> ,	CL = 50pF	2	-	150	190	225	ns
OE to Y	t <sub>PZL</sub> , t <sub>PZH</sub>	C <sub>L</sub> = 50pF	4.5	-	30	38	45	ns
		C <sub>L</sub> = 15pF	5	12	-	-	-	ns
		CL = 50pF	6	-	26	33	38	ns
Output Transition Times	t <sub>TLH</sub> , t <sub>THL</sub>	C <sub>L</sub> = 50pF	2	-	60	75	90	ns
			4.5	-	12	15	18	ns
			6	-	10	13	15	ns
Input Capacitance	Cl	-	-	-	10	10	10	pF
Three-State Output Capacitance	CO	-	-	-	20	20	20	pF
Power Dissipation Capacitance (Notes 5, 6)	C <sub>PD</sub>	-	5	45	-	-	-	pF
HCT TYPES	_						!	
Propagation Delay	t <sub>PLH</sub> , t <sub>PHL</sub>	C <sub>L</sub> = 50pF	4.5	-	33	41	50	ns
In to Y		C <sub>L</sub> = 15pF	5	13	-	-	-	ns
Propagation Delay	t <sub>PZL</sub> , t <sub>PZH</sub>	C <sub>L</sub> = 50pF	4.5	-	38	48	57	ns
S to Y		C <sub>L</sub> = 15pF	5	12	-	-	-	ns
Propagation Delay	t <sub>PLZ</sub> , t <sub>PHZ</sub>	C <sub>L</sub> = 50pF	4.5	-	30	38	45	ns
OE to Y		C <sub>L</sub> = 15pF	5	16	-	-	-	ns
Output Transition Times	t <sub>TLH</sub> , t <sub>THL</sub>	C <sub>L</sub> = 50pF	4.5	-	12	15	18	ns
Input Capacitance	Cl	-	-	-	10	10	10	pF
Three-State Output Capacitance	CO	-	-	-	20	20	20	pF
Power Dissipation Capacitance (Notes 5, 6)	C <sub>PD</sub>	-	5	45	-	-	-	pF

#### NOTES:

- 5. C<sub>PD</sub> is used to determine the dynamic power consumption, per multiplexer.
  6. P<sub>D</sub> = V<sub>CC</sub><sup>2</sup> f<sub>i</sub> (C<sub>PD</sub> + C<sub>L</sub>) where f<sub>i</sub> = Input Frequency, C<sub>L</sub> = Output Load Capacitance, V<sub>CC</sub> = Supply Voltage.

#### Test Circuits and Waveforms

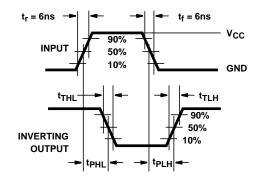


FIGURE 1. HC TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC

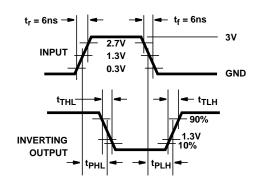


FIGURE 2. HCT TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC

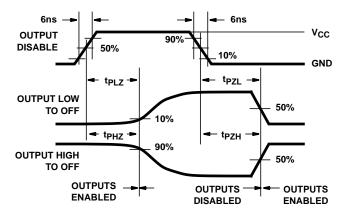


FIGURE 3. HC THREE-STATE PROPAGATION DELAY WAVEFORM

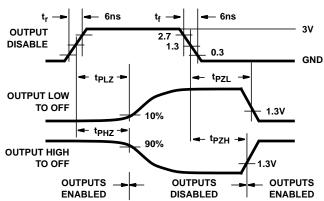
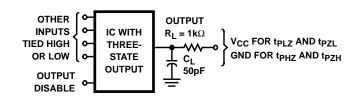


FIGURE 4. HCT THREE-STATE PROPAGATION DELAY WAVEFORM



NOTE: Open drain waveforms  $t_{PLZ}$  and  $t_{PZL}$  are the same as those for three-state shown on the left. The test circuit is Output  $R_L = 1k\Omega$  to  $V_{CC}$ ,  $C_L = 50pF$ .

FIGURE 5. HC AND HCT THREE-STATE PROPAGATION DELAY TEST CIRCUIT

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